

covering Electronic Components,
Assemblies, Related Materials and Processes

For rules and details of the IECQ visit www.iecq.org

Schedule of Scope to Certificate of Approval

Independent Testing Laboratory IECQ Certificate No.: IECQ-L JQAJP 13.0002

CB Certificate No.: JQAQ0002-001-T

Schedule Number: IECQ-L JQAJP 13.0002-S Rev No.: 9 Revision Date: 2021/01/06 Page 1 of 8

TESTD PARTS

Fixed capacitor, Fixed resistor, Potentiometer, Varistor, Thermistor, Connector, Relay, Switch, Printed circuit board, Semiconductor Devices, Semiconductor Integrated Circuit and Optical Component

ENVIRONMENTAL TEST

IEC 60068-2-1:2007	Cold
IEC 60068-2-2:2007	Dry heat
IEC 60068-2-11:1981	Salt mist
IEC 60068-2-14:2009	Change of temperature
IEC 60068-2-20:2008	Test methods for solderability and resistance
	to soldering heat of devices with leads
IEC 60068-2-30:2005	Damp heat, cyclic (12+12-hour cycle)
IEC 60068-2-38:2009	Composite temperature/humidity cyclic test
JIS C 60068-2-42:1993	Sulphur dioxide test for contacts and connections
JIS C 60068-2-43:1993	Hydrogen sulphide test for contacts and connections
IEC 60068-2-45:1980	Immersion in cleaning solvents
JIS C 60068-2-52:2000	Salt mist, cyclic (sodium chloride solution)
IEC 60068-2-54:2006	Soldering. Solderability testing by
	the wetting balance method
JIS C 60068-2-58:2016	Test methods for solderability, resistance to dissolution of
	metallization and to soldering heat of SMD
IEC 60068-2-60:2015	Flowing mixed gas corrosion test
IEC 60068-2-66:1994	Damp heat, steady state (unsaturated pressurized vapour)
IEC 60068-2-78:2012	Damp heat, steady state
MIL STD 202H	Test method standard electronic and electrical component parts
MIL STD 883K	Test method standard microcircuts





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MECHANICAL TEST

IEC 60068-2-6:2007 Vibration (sinusoidal)

IEC 60068-2-21:2006 Robustness of terminations and

integral mounting devices

IEC 60068-2-27:2008 Shock

IEC 60068-2-31:2008 Rough handling shocks, primarily for

equipment-type specimens

IEC 60068-2-53:2010 Tests and Guidance: Combined climatic (temperature/humidity)

and dynamic (vibration/shock) tests

STRESS TEST

JEITA ED-4701/302:2013

Environmental and endurance test methods for semiconductor devices (Stress test I-2)

Test method 304A Human body model electrostatic discharge (HBM/ESD)
Test method 305C Charged device model electrostatic discharge (CDM/ESD)

Test method 306B Latch-up







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LED OPTICAL CHARACTERISTIC TEST

JIS C 7801:2009 Measuring methods of lamps for general lighting
JIS C 8152-1:2012 Photometry of white light emitting diode for
general lighting — Part 1: LED packages

JIS C 8152-2:2012 Photometry of white light emitting diode for general lighting

Part 2: LED modules and LED light engines

JIS C 8105-5:2011 Luminaires — Part 5: Gonio-photometric method

OTHER TEST

Failure Analysis, Construction Analysis, Elemental Analysis, Thermal Analysis and Internal Gas Analysis of Electronic component, including Electrical Analysis, NDE (Non-destructive Engineering), PhysicalAnalysis, Chemical Analysis and Sample Preparation (Decap, X-section, etc),







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MEASUREMENT RANGE

Passive component

Type / Part name	Measurable property value	Measuring range
	(1)Voltage endurance (DC)	: AC,DC $0 \sim 5 \text{kV}$
	(2)Insulation resistance	$:5\times10^{5}\Omega\sim10^{14}\Omega$
	(3)leakage current	$1 \times 10^{-3} \sim 10 \text{ A}^{-11}$
	(4)Capacitance	: 18pF ~ 1F*
Fixed capacitor	(5)Dielectric loss tangent(D factor)	: 10* min
	(6)Impedanc	: $1\Omega \sim 10^* M\Omega$
	(7)Temperature properties and	
	gap of the capacitance.	: Temperature range $-40^{\circ}\text{C} \sim +150^{\circ}\text{C}$
	Attention: * The mark varies	according to measurement frequency.
	(1)Resistance value	$:1 \Omega \sim 100 M\Omega$
	(2)Resistance temperature properties and	d
Fixed resistor	gap of the resistance level.	:Temperature range $-55^{\circ}\text{C} \sim +150^{\circ}\text{C}$
rixed resistor	(3)Voltage factor	:±0.02%/V
	(4)Insulation resistance	: $5 \times 10^5 \Omega \sim 2 \times 0^{14} \Omega$
	(5)Voltage endurance	: AC,DC $0 \sim 5$ kV
	(1)Resistance value	: $1 \Omega \sim 100 M\Omega$
	(2)Mutual deviations	: ±3%
	(3)Resistance temperature properties and	d
Variable resistor	gap of the resistance level.	:Temperature range $-40^{\circ}\text{C} \sim +150^{\circ}\text{C}$
*potentiometer	(4)Insulation resistance	: $5 \times 10^5 \Omega \sim 10^{14} \Omega$
	(5)Voltage endurance	: AC,DC $0 \sim 5$ kV
	(6)Rotational noise	:Noise voltage 1mV
	(7)Intensive contact resistance	:1 mΩ
Varistor	Voltage at reference current	:1500V(1mA min)
Thermistor	(1)resistance value	$:1\Omega \sim 1000 k\Omega$
	(2)The thermistor fixed number	:Temperature range $-50^{\circ}\text{C} \sim +300^{\circ}\text{C}$





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MEASUREMENT RANGE

Active component part [Individual semiconductor part]

Type / Part name	Measurable property value Measurable property value	easuring range
	(1)Collector-base breakdown voltage	
	(2)Collector-emitter breakdown voltage	:1V ~ 1.5kV
	(3)Emitter base breakdown voltage	:100V min
Transistor	(4)Collector base interception electric curr	rent $:1nA \sim 100mA$
*Bipolar	(5)Collector emitter interception electric c	urrent $:1nA \sim 100mA$
	(6)Emitter base interception electric currer	$nt : 1nA \sim 100mA$
	(7)The collector emitter saturation voltage	:7V min $(I_C < 17A)$
	(8)DC current gain	$:25 \sim 25,000 (I_C < 17A)$
	(1)Gate source breakdown voltage	:1V ~ 1.5kV
Transistor	(2)Gate leak electric current	$:1pA \sim 100mA$
*Field effect form	(3)Drain current	$:1nA \sim 1A$
"Field effect form	(4)The gate cut-off voltage	: ∼ 100V
	(5)The drain source saturation voltage	:7V min (I _D < 17A)
Diode	(1)Forward voltage	:7V min $(I_F < 17A)$
*Small signal	(2)Reverse current	$:1na \sim 100mA (V_R < 100V)$
*I rectify a small electric current	(3)Breakdown voltage	:1V ~ 1.5kV
*Constant voltage	(4)Zener voltage	:100V min
*Small electric current switching	(5)Dynamic resistance	$:50\Omega$ max
	(6)Temperature coefficient	:Temperature range $-55^{\circ}\text{C} \sim +150^{\circ}\text{C}$
Thyristor	(1)Off electric current	$:1 \text{mA} (V_L < 1 \text{kV})$
*3 reverse-blocking terminals	(2)Reverse current	$:1$ na ~ 1 mA ($V_L \le 1$ kV)
*Small electric current	(3)ON-state voltage	$:7V (I_{TM} < 10A)$
	(4)Gate trigger	:1000V min
	(5)Holding current	$:10A(V_{TM} < 7V)$





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MEASUREMENT RANGE

Active component part Semicondctor Devices [Integrated circuit]

Type / Part name	Measurable property value Me	easuring range
	(1)The high-level output voltage	:±30V
	(2)The low-level output voltage	:±30V
	(3)The input clamp voltage	:±30V
TTL IC	(4)High-level input electric current	:±300mA
TILIC	(5)Low-level input electric current	:±300mA
	(6)Output short circuit current	:±300mA
	(7)High-level power supply electric current	
	(8)Low-level power supply electric current	
	(1)The high-level output voltage	:±30V
	(2)The low-level output voltage	:±30V
	(3)The high-level input voltage	:±20V
CMOS IC	(4)Low-level input electric current	:±20V
CWOS IC	(5)High-level output electric current	:±300mA
	(6)Low-level output electric current	:±300mA
	(7)Static consumption electric current	:±300mA
	(8)Input current	:±300mA
	(1)Input-offset voltage	$:10\mu V\sim 128mV$
	(2)Input offset current	$:20pA \sim 16\mu A$
	(3)Input bias current	$:20pA \sim 16\mu A$
Analog semiconductor integrated	(4)Open loop voltage gain	$: 0.1 V/mV \sim 1.2 V/\mu V$
circuit *Monolithic op-amp	(5)The max power voltage	$:10 \text{mV} \sim 50 \text{V}$
	(6)Power consumption	$:5 \text{mW} \sim 6.4 \text{W}$
	(7)Common mode rejection ratio	:38 ~ 116dB
	(8)Supply voltage rejection ratio	:38 ~ 116dB
	(9)Aspect input voltage range	$:100 \text{mV} \sim 25 \text{V}$
	(10)Slew rate	$:0.1 \sim 125 V/\mu S$





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MEASUREMENT RANGE

Mechanical device

Type / Part name	Measurable property value	Measuring range
Connector	(1)Insulationresistanc	$:5\times 10^{5}\Omega \sim 2\times 10^{14}\Omega$
	(2)Withstand voltage	:AC,DC 0 ~ 5kV
	(3)Contact resistance under low voltage,	,
(Electronic equipment use)	the low electric current	$:1m\Omega \sim 100\Omega$
	(4)Chattering of the contact.	:1μsec max
	(1)Withstand voltage	:AC,DC 0 ~ 5kV
	(2)Insulation resistance	$:5\times 10^{5}\Omega \sim 2\times 10^{14}\Omega$
	(3)Direct current resistance of the coil	$:1\Omega \sim 10 k\Omega$
	(4)Contact resistance	$:1m\Omega \sim 100\Omega$
Relay	(5)Operating voltage	:1V max
(Small form for control)	(6)Must-release voltage	:1V max
	(7)Operation time	:1msec max
	(8)Recovery time	:1msec max
	(9)Bounces of the point of contact	:1μsec max
	(10)Chattering of the point of contact	:1µsec max
	(1)Contact resistance	$:1m\Omega \sim 100\Omega$
Switch	(2)Insulation resistance	$:5\times10^{5}\Omega\sim2\times10^{14}\Omega$
	(3)Withstand voltage	: AC,DC $0 \sim 5$ kV
(Electronic equipment use)	(4)Electrostatic capacity	:18pF ~ 1F
	(5)Change of the contact resistance	:1mΩ max
Printed circuit board	(1)Resistance of the plating part of	
	the conductor and through hall p	part. : $1 \text{m}\Omega \sim 1000\Omega$
	(2)Withstand voltage	: AC,DC $0 \sim 5 \text{kV}$
	(3)Insulation resistance	$: 5 \times 10^5 \Omega \sim 10^{14} \Omega$





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MEASUREMENT RANGE

Optical component

Type / Part name	Measurable property value	Measuring range
Luminescent diode (It is for indication.)	(1)Forward voltage	:7V min
	(2)Reverse current	:1mA min
	(3)Luminous intensity(Relative va	lue) :
	1.Integrating sphere	
	(1)Total luminous flux[lm]	:Measurable wavelength range
		$350\text{nm} \sim 1000\text{nm}$
		In sunshine: min 32lm ~
	(2)Color temperature[K]	:
	(3)Chromaticity coordinate	:
	(4)The number of the color ren	dering evaluations :Ra,R1 ~ R14
	2.The light distribution measurement	ent.
LED	(1)Light distribution curve	:Measurable wavelength range
(It is for illumination.)		$360\text{nm} \sim 830\text{nm}$
		:Photometric distance 2m ~ 12m,
	(2)Light intensity(Reference)	:Photometric distance Luminous intensity
		:2.0m: $9 \sim 3,680,000$ [cd]
		:3.0m: $20 \sim 8,200,000$ [cd]
		:6.0m: $83 \sim 33,000,000$ [cd]
		:12m: $330 \sim 132,000,000$ [cd]
	(3)Color temperature	:
	(4)Chromaticity coordinate	:
	(5) The number of the color rendering evaluations: Ra,R1 ~ R14	

